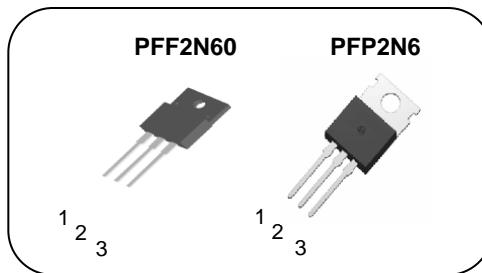


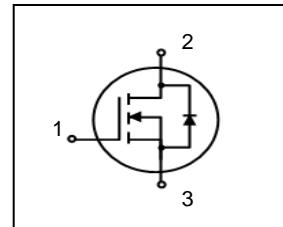
## N-channel MOSFET

### Features

- High ruggedness
- $R_{DS(ON)}$  (Max 5.0  $\Omega$ )@ $V_{GS}=10V$
- Gate Charge (Max 6.6nC)
- Improved dv/dt Capability
- 100% Avalanche Tested



**BV<sub>DSS</sub>** : 600V  
**I<sub>D</sub>** : 2.0A  
**R<sub>DS(ON)</sub>** : 5.0ohm



### General Description

These N-channel enhancement mode field effect power transistor is using PowerGate semiconductor's advanced planar stripe, DMOS technology intended for off line switch mode power supply. Also, especially designed to minimize  $R_{DS(ON)}$  and high rugged avalanche characteristics. These devices are well suited for high efficiency switching Mode power supplies, active power factor correction, TV and monitor.

### Absolute maximum ratings

Symbol	Parameter	Value		Unit
		PFP2N60	PFF2N60	
$V_{DSS}$	Drain to Source Voltage	600		V
$I_D$	Continuous Drain Current (@ $T_C=25^\circ C$ )	2.0	2.0*	A
	Continuous Drain Current (@ $T_C=100^\circ C$ )	1.6	1.6*	A
$I_{DM}$	Drain current pulsed (note 1)	8.0		A
$V_{GS}$	Gate to Source Voltage	$\pm 30$		V
$E_{AS}$	Single pulsed Avalanche Energy (note 2)	140		mJ
$E_{AR}$	Repetitive Avalanche Energy (note 1)	2.8		mJ
$dv/dt$	Peak diode Recovery $dv/dt$ (note 3)	4.5		V/ns
$P_D$	Total power dissipation (@ $T_C=25^\circ C$ )	64	28	W
	Derating Factor above 25°C	0.5	0.21	W/°C
$T_{STG}, T_J$	Operating Junction Temperature & Storage Temperature	$-55 \sim +150$		°C
$T_L$	Maximum Lead Temperature for soldering purpose, 1/8 from Case for 5 seconds.	300		°C

\*. Drain current limited by maximum junction temperature.

### Thermal characteristics

Symbol	Parameter	Value		Unit
		PFP2N60	PFF2N60	
$R_{thJC}$	Thermal resistance, Junction to case	1.95	4.5	°C/W
$R_{thCS}$	Thermal resistance, Case to Sink	0.5		°C/W
$R_{thJA}$	Thermal resistance, Junction to ambient	62.5		°C/W

# PFP2N60/PFF2N60



Electrical characteristic (  $T_C = 25^\circ\text{C}$  unless otherwise specified )

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$BV_{DSS}$	Drain to source breakdown voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	600	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu\text{A}$ , referenced to $25^\circ\text{C}$	-	0.38	-	$^\circ\text{C}$
$I_{DSS}$	Drain to source leakage current	$V_{DS}=600\text{V}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{DS}=480\text{V}, T_C=125^\circ\text{C}$	-	-	10	$\mu\text{A}$
$I_{GSS}$	Gate to source leakage current, forward	$V_{GS}=30\text{V}, V_{DS}=0\text{V}$	-	-	100	nA
	Gate to source leakage current, reverse	$V_{GS}=-30\text{V}, V_{DS}=0\text{V}$	-	-	-100	nA
<b>On characteristics</b>						
$V_{GS(\text{TH})}$	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	4.0	-	5.0	V
$R_{DS(\text{ON})}$	Drain to source on state resistance	$V_{GS}=10\text{V}, I_D = 1.0\text{A}$		4.1	5	$\Omega$
<b>Dynamic characteristics</b>						
$C_{iss}$	Input capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$	-	317	-	pF
$C_{oss}$	Output capacitance		-	41	-	
$C_{rss}$	Reverse transfer capacitance		-	5.6	-	
$t_{d(on)}$	Turn on delay time	$V_{DS}=300\text{V}, I_D=1.0\text{A}, R_G=25\Omega$	-	10.6	-	ns
$tr$	Rising time		-	9.4	-	
$t_{d(off)}$	Turn off delay time		-	18.4	-	
$t_f$	Fall time		-	9.7	-	
$Q_g$	Total gate charge	$V_{DS}=480\text{V}, V_{GS}=10\text{V}, I_D=2.0\text{A}$	-	6.6	20	nC
$Q_{gs}$	Gate-source charge		-	1.8	-	
$Q_{gd}$	Gate-drain charge		-	2.7	-	

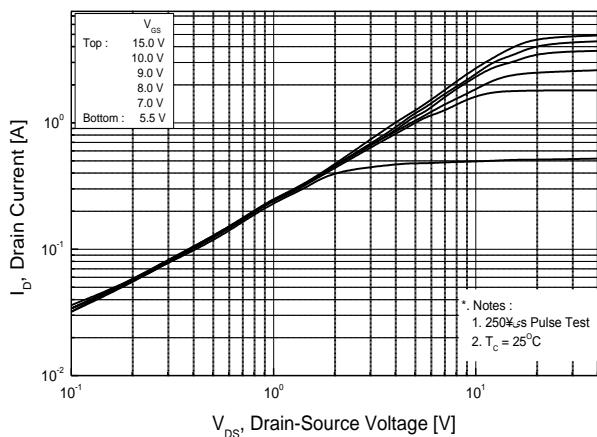
## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET	-	-	2.0	A
$I_{SM}$	Pulsed source current		-	-	8.0	A
$V_{SD}$	Diode forward voltage drop.	$I_s=2.0\text{A}, V_{GS}=0\text{V}$	-	-	1.5	V
$T_{rr}$	Reverse recovery time	$I_s=2.0\text{A}, V_{GS}=0\text{V}, dI_F/dt=100\text{A}/\mu\text{s}$	-	291	-	ns
$Q_{rr}$	Breakdown voltage temperature		-	1.0	-	nC

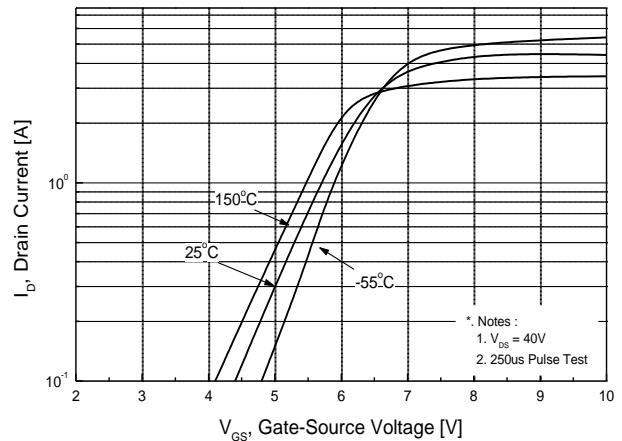
\*. Notes

1. Repetitive rating : pulse width limited by junction temperature.
2.  $L = 44.7\text{mH}, I_{AS} = 2.0\text{A}, V_{DD} = 50\text{V}, R_G=50\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq 2.0\text{A}, dI/dt = 300\text{A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$
5. Essentially independent of operating temperature.

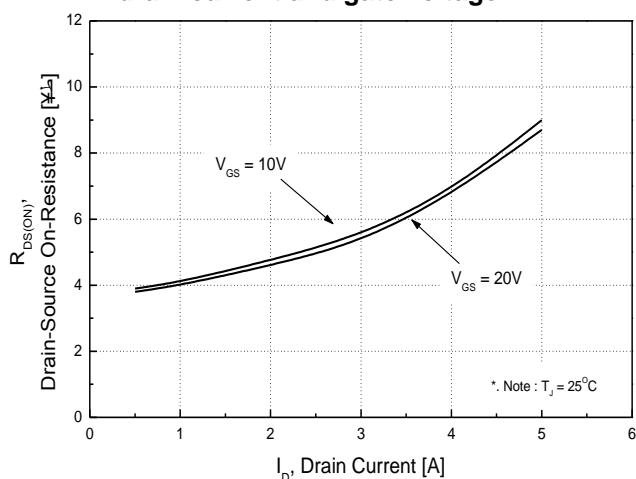
**Fig. 1. On-state characteristics**



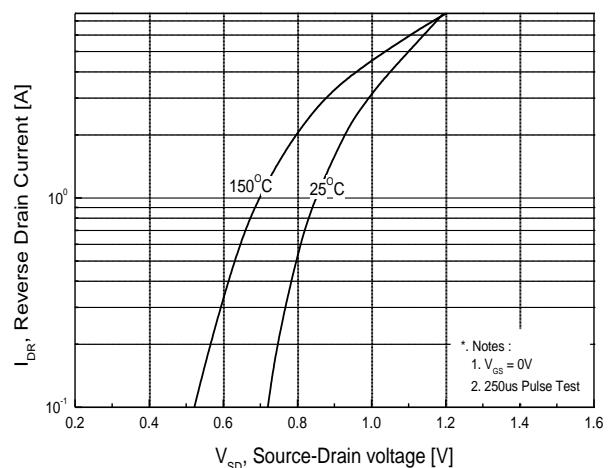
**Fig. 2. Transfer characteristics**



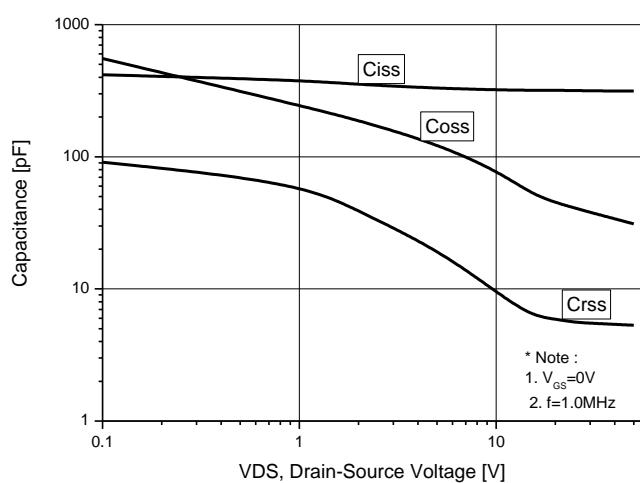
**Fig. 3. On-resistance variation vs. drain current and gate voltage**



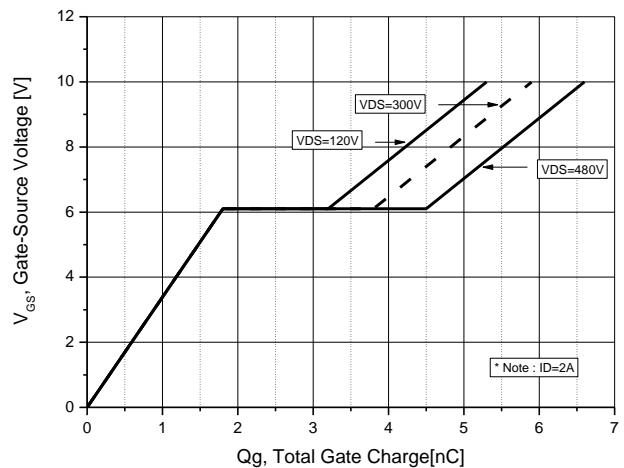
**Fig. 4. On state current vs. diode forward voltage**



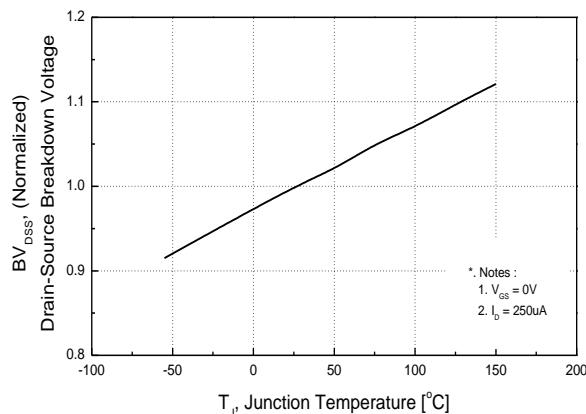
**Fig. 5. Capacitance characteristics (Non-Repetitive)**



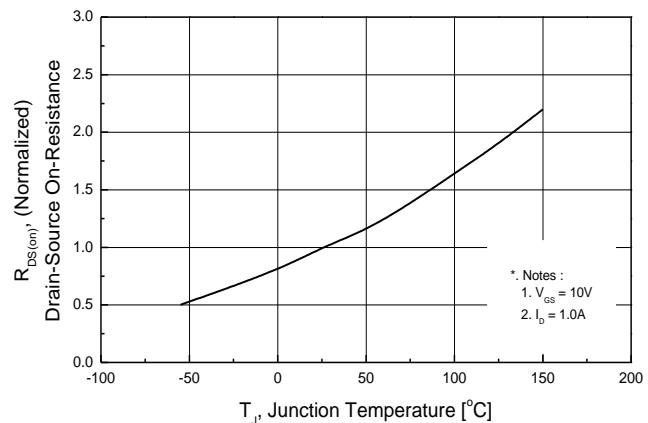
**Fig. 6. Gate charge characteristics**



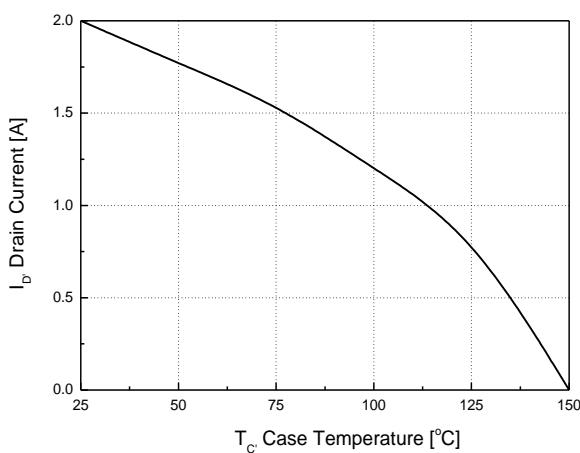
**Fig. 7. Breakdown Voltage Variation vs. Junction Temperature**



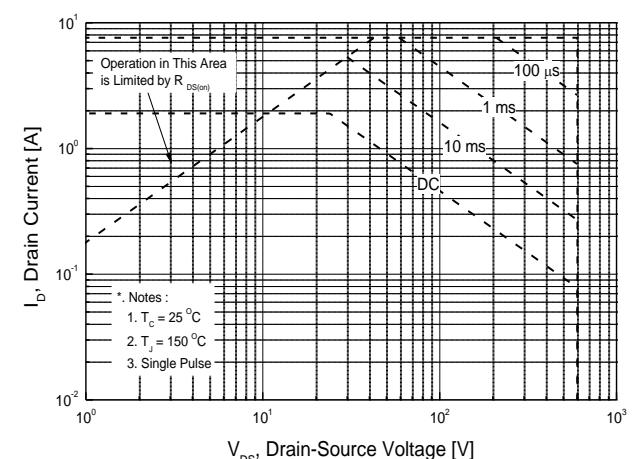
**Fig. 8. On resistance variation vs. junction temperature**



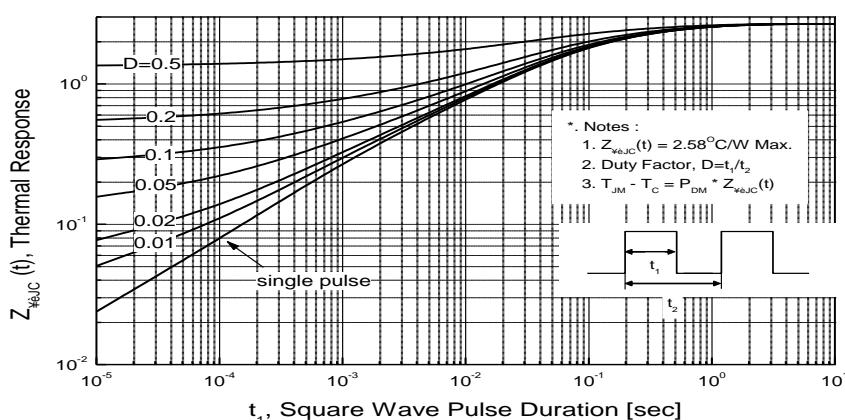
**Fig. 9. Maximum drain current vs. case temperature.**



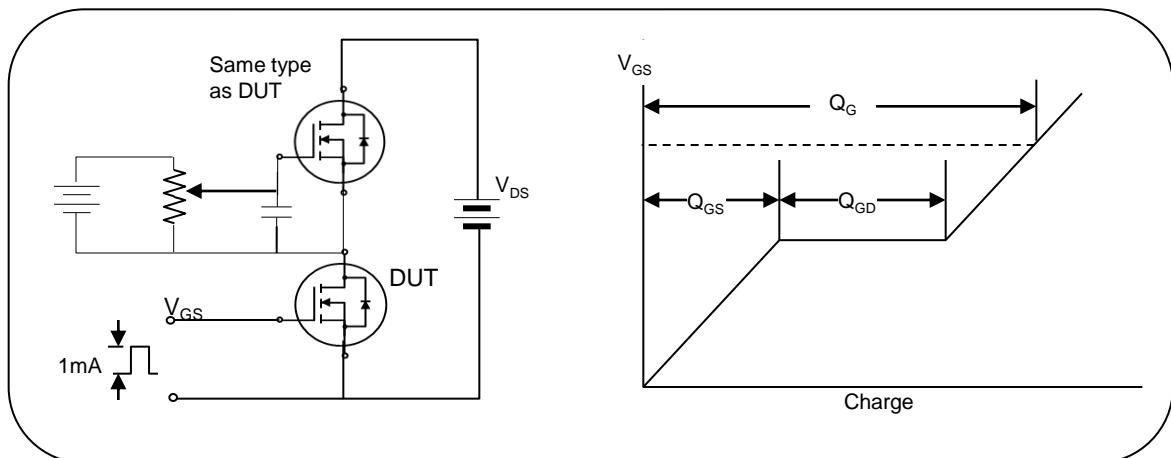
**Fig. 10. Maximum safe operating area (TO-220)**



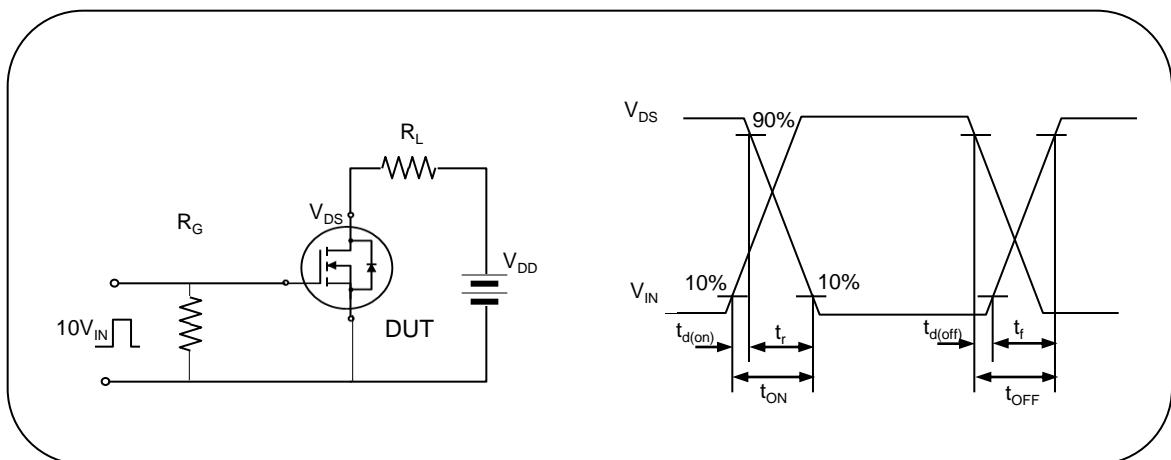
**Fig. 11. Transient thermal response curve**



**Fig. 12. Gate charge test circuit & waveform**



**Fig. 13. Switching time test circuit & waveform**



**Fig. 14. Unclamped Inductive switching test circuit & waveform**

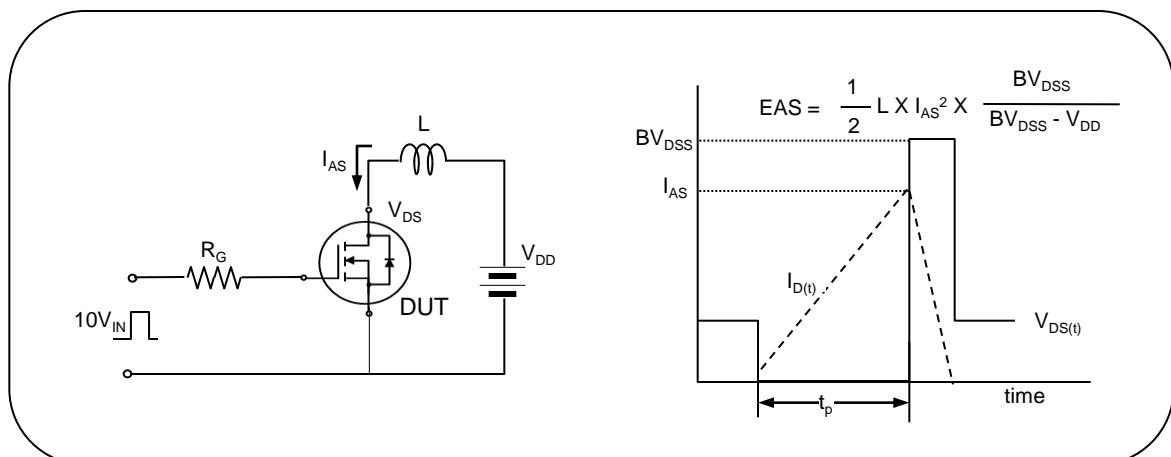
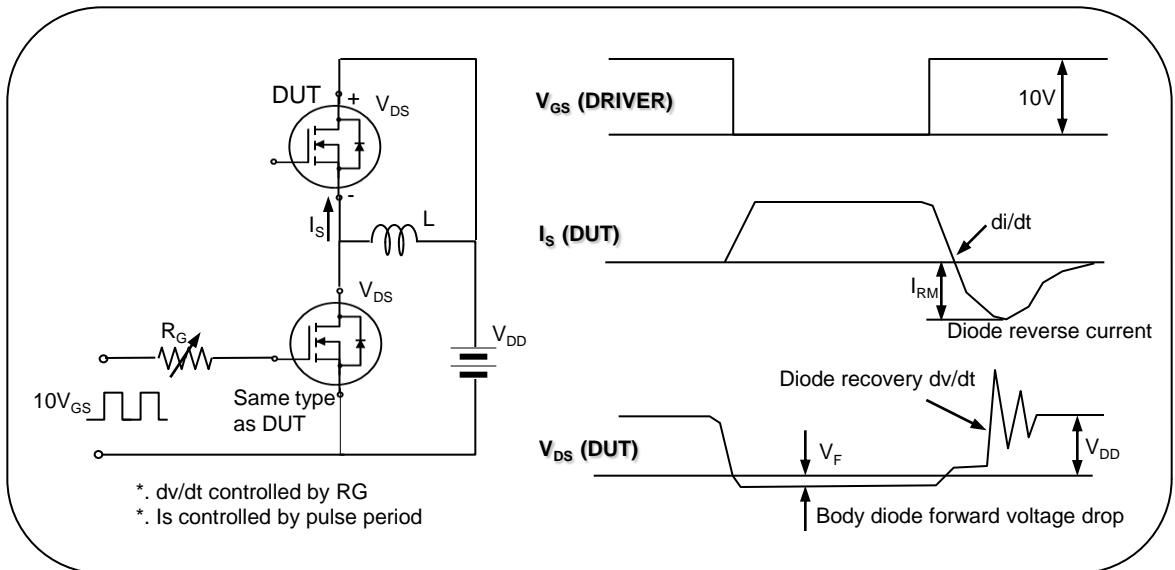
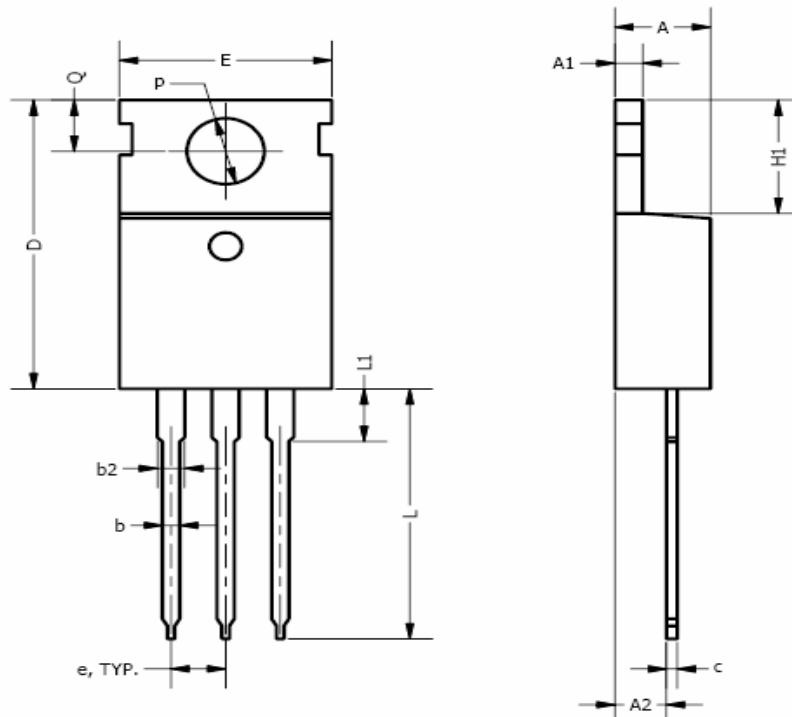


Fig. 15. Peak diode recovery dv/dt test circuit & waveform

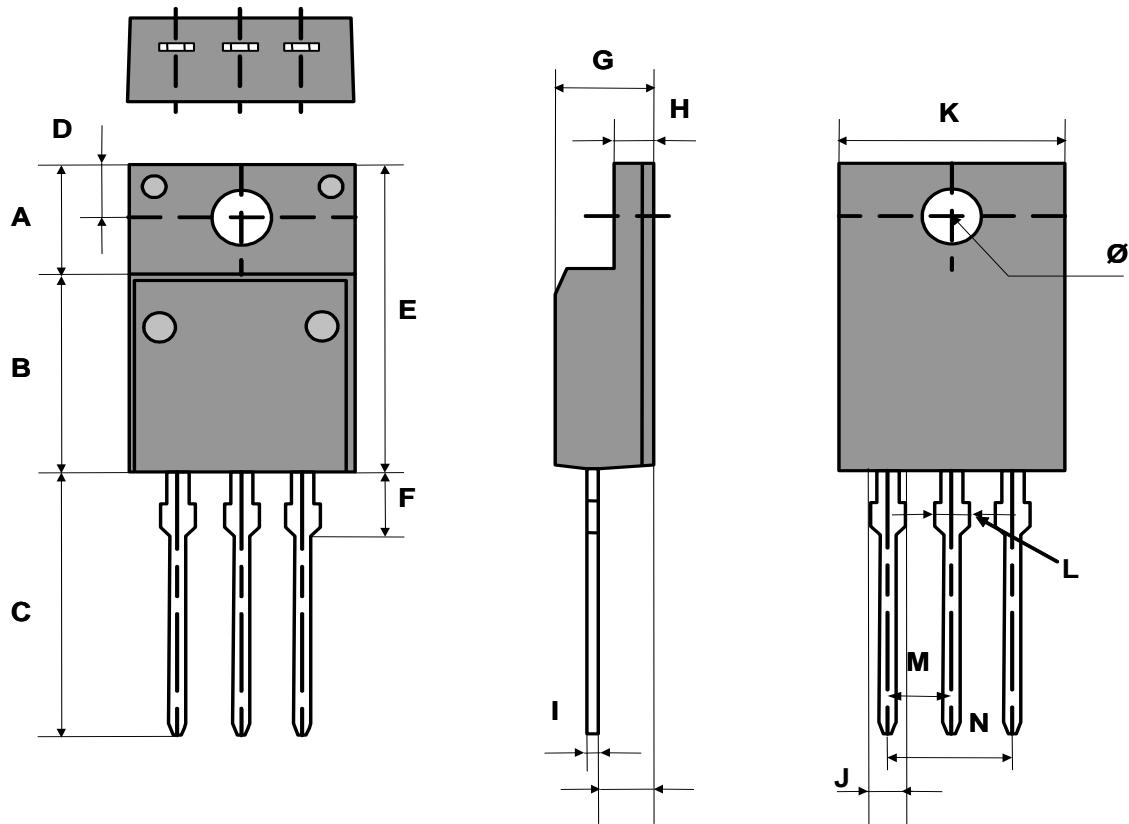


## TO-220 Package Dimension



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.14	0.19	3.56	4.83
A1	0.02	0.055	0.51	1.4
A2	0.08	0.115	2.03	2.92
b	0.015	0.04	0.38	1.02
b2	0.045	0.07	1.14	1.78
c	0.014	0.024	0.36	0.61
D	0.56	0.65	14.22	16.51
e	0.096	0.104	2.44	2.64
E	0.38	0.42	9.65	10.67
H1	0.23	0.27	5.84	6.86
L	0.5	0.58	12.7	14.73
L1	-	0.25	-	6.35
CP	0.139	0.161	3.53	4.09
Q	0.1	0.135	2.54	3.43

## TO-220F Package Dimension



DIMENSION		A	B	C	D	E	F	G	H
mm	Min	6.00	7.85	12.88	3.00	15.0	3.15	4.45	3.05
	Typ.	6.05	7.90	13.08	3.02	15.2	3.25	4.50	3.10
	Max	6.10	7.95	13.28	3.04	15.4	3.35	4.55	3.15

DIMENSION		I	J	K	L	M	N	Ø	
mm	Min	0.585	1.245	9.95	1.65	2.00	4.58	2.90	
	Typ.	0.595	1.250	10.00	1.66	2.05	4.60	2.95	
	Max	0.605	1.255	10.05	1.67	2.10	4.62	3.00	